

Load Switch with Low On-Resistance (Current Limit 400mA)

■ GENERAL DESCRIPTION

The XC8102 series is a low ON resistance load switch IC with ON/OFF control and output current protection which integrates a P-channel MOSFET.

By connecting the XC8102 to the output pin of a step-down DC/DC converter, the CE pin controls ON/OFF for each distribution switch to deliver power per requirements and maximize total power efficiency. As a result, the XC8102 helps to extend battery life and product operation time.

The series contains a current limit and protection circuit so these are not required externally unlike discrete circuit solutions where MOSFETs and resistors are used.

When a low signal is input to the CE pin, the series enters stand-by mode. Even where a load capacitor is connected to the output pin during stand-by, the electric charge stored at the load capacitor is discharged through the internal switch. As a result, the V_{OUT} pin voltage falls quickly to the V_{SS} level.

The series contains over current protection with fold-back current circuitry which operates as over current protection and short circuit protection for the output pin.

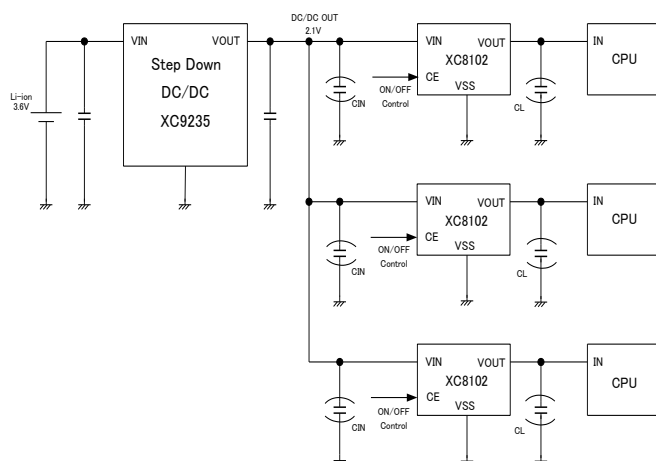
■ APPLICATIONS

- Smart phones / Mobile phones
- Digital still cameras / Camcorders
- Portable game consoles

■ FEATURES

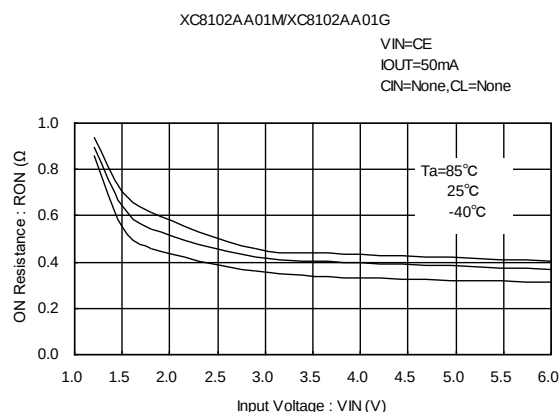
On Resistance	: 0.28Ω@ V _{IN} =6.0V (TYP.) 0.31Ω@ V _{IN} =4.0V (TYP.) 0.35Ω@ V _{IN} =2.9V (TYP.) 0.52Ω@ V _{IN} =1.8V (TYP.) 0.60Ω@ V _{IN} =1.5V (TYP.) 0.80Ω@ V _{IN} =1.2V (TYP.)
Input Voltage Range	: 1.2V ~ 6.0V
Power Consumption	: 3.0 μA@ V _{IN} =1.2V 3.6 μA@ V _{IN} =2.9V 4.0 μA@ V _{IN} =6.0V
Stand-by Current	: 0.1 μA
Protection Circuit	: Current limit(Output Current) 400mA (1.8 ≤ V _{IN} ≤ 6.0V) Short-circuit Protection, Short current= 30mA (TYP.)
ON/OFF Function	: Active High Enable High-Speed Discharge Function
Operating Ambient Temperature	: -40°C ~ 85°C
Packages	: USP-4, SSOT-24, SOT-25, USP-N-4, USP-6B06
Environmentally Friendly	: EU RoHS Compliant, Pb Free

■ TYPICAL APPLICATION CIRCUIT

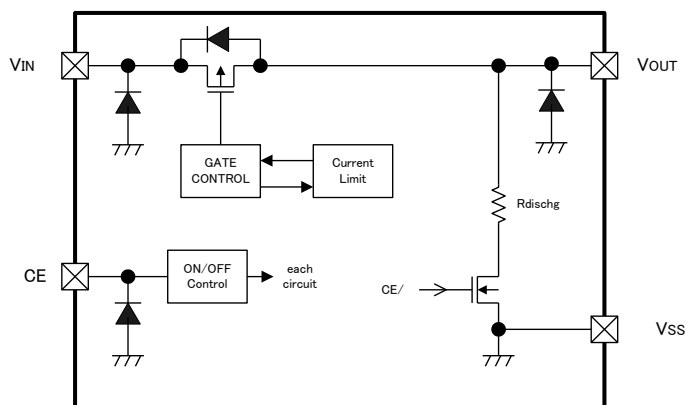


■ TYPICAL PERFORMANCE CHARACTERISTICS

● On Resistance vs. Input Voltage



■ BLOCK DIAGRAM



XC8102AA Series

* Diodes inside the circuit are an ESD protection diode and a parasitic diode.

■ PRODUCT CLASSIFICATION

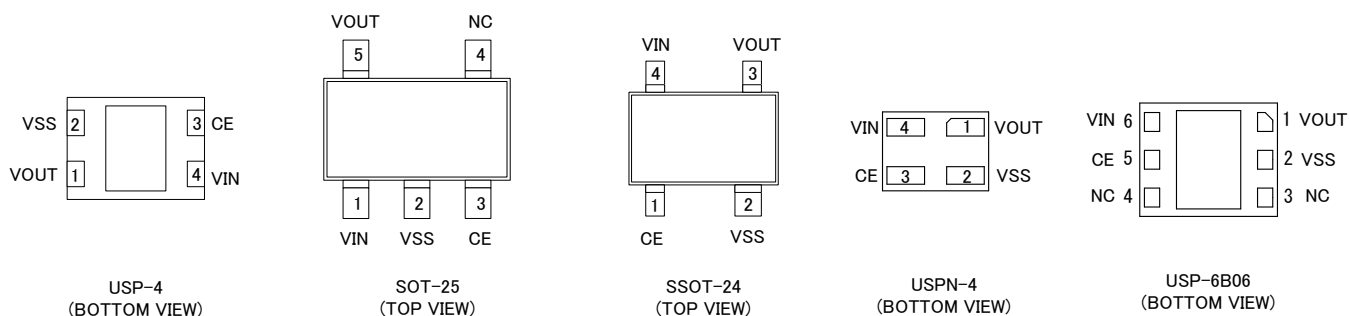
● Ordering Information

XC8102①②③④⑤⑥-⑦^(*)

DESIGNATOR	ITEM	SYMBOL	DESCRIPTION
①	CE pin logic	A	CE High active
②	C _L Discharge Function	A	C _L auto-discharge function
③④	Internal Standard Number	01	Fixed
⑤⑥-⑦ ^(*)	Packages (Order Unit)	GR-G	USP-4 (3,000pcs/Reel)
		MR-G	SOT-25 (3,000pcs/Reel)
		NR-G	SSOT-24 (3,000pcs/Reel)
		7R-G	USPN-4 (5,000pcs/Reel)
		8R-G	USP-6B06 (5,000pcs/Reel)

^(*) The “-G” suffix denotes Halogen and Antimony free as well as being fully EU RoHS compliant.

PIN CONFIGURATION



*The heat dissipation pad of the USP-4 and USP-6B06 package is recommended to solder as shown in the recommended mount pattern and metal mask pattern for mounting strength. The heat dissipation pad should be electrically opened or connected to the V_{SS} (No. 2) pin.

PIN ASSIGNMENT

PIN NUMBER					PIN NAME	FUNCTIONS
USP-4	SOT-25	SSOT-24	USPN-4	USP-6B06		
4	1	4	4	6	V_{IN}	Power Input
1	5	3	1	1	V_{OUT}	Output
2	2	2	2	2	V_{SS}	Ground
3	3	1	3	5	CE	ON/OFF Control
—	4	—	-	3,4	NC	No Connection

FUNCTION

PIN NAME	SIGNAL	STATUS
CE	H	Active
	L	Stand-by
	OPEN	Undefined state

H = High Level
L = Low Level

* CE pin should not be left open.

■ ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	RATINGS	UNITS
Input Voltage		V _{IN}	-0.3 ~ 6.5	V
Output Current		I _{OUT}	850 ^(*1)	mA
			750 (USPN-4) ^(*1)	
Output Voltage		V _{OUT}	-0.3 ~ V _{IN}	V
CE Input Voltage		V _{CE}	-0.3 ~ 6.5	V
Power Dissipation (Ta=25°C)	USP-4	Pd	120	mW
			1000 (40mm x 40mm standard board) ^(*2)	
	SSOT-24		150	
			500 (40mm x 40mm standard board) ^(*2)	
	SOT-25		680(JESD51-7 board)	
			250	
			600 (40mm x 40mm standard board) ^(*2)	
	USPN-4		760 (JESD51-7 board)	
			100	
	USP-6B06		600 (40mm x 40mm standard board) ^(*2)	
		900 (40mm x 40mm standard board) ^(*2)		
Operating Ambient Temperature		Topr	-40 ~ 85	°C
Storage Temperature		Tstg	-55 ~ 125	°C

^(*) Please make sure that I_{OUT} is less than $P_d / (V_{IN} - V_{OUT})$

^(*) The power dissipation figure shown is PCB mounted and is for reference only.
The mounting condition is please refer to PACKAGING INFORMATION.

■ ELECTRICAL CHARACTERISTICS

● XC8102 Series

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUITS
Input Voltage	V_{IN}		1.2	-	6.0	V	-
On Resistance (SSOT-24/USPN-4)	R_{ON}	$V_{IN}=6.0V, V_{CE}=V_{IN}$	-	0.28	0.425	Ω	①
		$V_{IN}=4.0V, V_{CE}=V_{IN}$	-	0.31	0.475		
		$V_{IN}=2.9V, V_{CE}=V_{IN}$	-	0.35	0.475		
		$V_{IN}=1.8V, V_{CE}=V_{IN}$	-	0.52	0.625		
		$V_{IN}=1.5V, V_{CE}=V_{IN}$	-	0.60	0.80		
		$V_{IN}=1.2V, V_{CE}=V_{IN}$	-	0.80	1.60		
On Resistance (SOT-25/USP-4/ USP-6B06)	R_{ON}	$V_{IN}=6.0V, V_{CE}=V_{IN}$	-	0.35	0.475	Ω	①
		$V_{IN}=4.0V, V_{CE}=V_{IN}$	-	0.38	0.525		
		$V_{IN}=2.9V, V_{CE}=V_{IN}$	-	0.43	0.525		
		$V_{IN}=1.8V, V_{CE}=V_{IN}$	-	0.59	0.675		
		$V_{IN}=1.5V, V_{CE}=V_{IN}$	-	0.67	0.85		
		$V_{IN}=1.2V, V_{CE}=V_{IN}$	-	0.87	1.65		
Supply Current	I_{DD}	$V_{IN}=6.0V, V_{CE}=V_{IN}, V_{OUT}=OPEN$	-	4.0	7.0	μA	②
		$V_{IN}=4.0V, V_{CE}=V_{IN}, V_{OUT}=OPEN$	-	3.8	6.5		
		$V_{IN}=2.9V, V_{CE}=V_{IN}, V_{OUT}=OPEN$	-	3.6	6.3		
		$V_{IN}=1.8V, V_{CE}=V_{IN}, V_{OUT}=OPEN$	-	3.4	5.7		
		$V_{IN}=1.5V, V_{CE}=V_{IN}, V_{OUT}=OPEN$	-	3.2	5.5		
		$V_{IN}=1.2V, V_{CE}=V_{IN}, V_{OUT}=OPEN$	-	3.0	4.9		
Stand-by Current	I_{STBY}	$V_{IN}=6.0V, V_{CE}=V_{SS}, V_{OUT}=OPEN$	-	0.01	0.10	μA	②
Switch Leakage Current	I_{LEAK}	$V_{IN}=6.0V, V_{CE}=V_{SS}, V_{OUT}=0V$	-	0.01	0.10	μA	②
Current Limit	I_{LIM}	$V_{IN} \geq 2.9V, V_{OUT} = V_{IN} - 0.8V$	400	480	-	mA	①
		$1.8V \leq V_{IN} < 2.9V, V_{OUT} = V_{IN} - 0.6V$	400	480	-		
		$1.5V \leq V_{IN} < 1.8V, V_{OUT} = 1.2V$	200	-	-		
		$1.2V \leq V_{IN} < 1.5V, V_{OUT} = 1.0V$	90	-	-		
Short Circuit Current	I_{SHORT}	$V_{CE}=V_{IN}, V_{OUT}=0V$	-	30	75	mA	①
CE High Level Voltage	V_{CEH}		1.1	-	6.0	V	③
CE Low Level Voltage	V_{CEL}		V_{SS}	-	0.3	V	③
CE High Level Current	I_{CEH}	$V_{CE}=V_{IN}$	-0.1	-	0.1	μA	③
CE Low Level Current	I_{CEL}	$V_{CE}=V_{SS}$	-0.1	-	0.1	μA	③
C_L Auto-Discharge Resistance	R_{DCHG}	$V_{IN}=4.0V, V_{OUT}=4.0V, V_{CE}=V_{SS}$	380	480	570	Ω	④
Turn On Time 1 (*1) (*3)	$t_{DLY1(ON)}$	$V_{IN}=4.0V, V_{CE}=0.3V \rightarrow 1.2V, R_L=80\Omega$, without C_{IN}, C_L	-	8.5	18	μs	⑤
Turn On Time 2 (*2)	$t_{DLY2(ON)}$	$V_{IN}=4.0V, V_{CE}=0.3V \rightarrow 1.2V, R_L=80\Omega$, without C_{IN}, C_L	-	50	150	μs	⑤
Turn Off Time (*2)	$t_{DLY(OFF)}$	$V_{IN}=4.0V, V_{CE}=1.2V \rightarrow 0.3V, R_L=80\Omega$, without C_{IN}, C_L	-	3.0	7.5	μs	⑤

NOTE:

*1: Time to reach 90% of V_{OUT} after V_{CE} entering the V_{CEH} threshold.

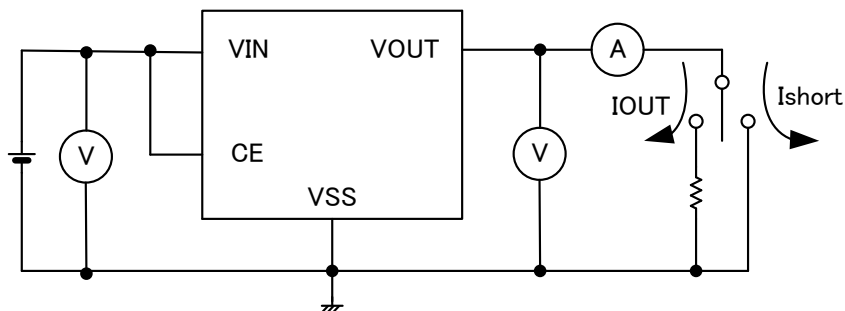
*2: Time to fall to 10% of V_{OUT} after V_{CE} entering the V_{CEL} threshold.

*3: Restart time after startup (■ OPERATIONAL EXPLANATION <Turn-on time, Turn-off time TIMING CHART>③)

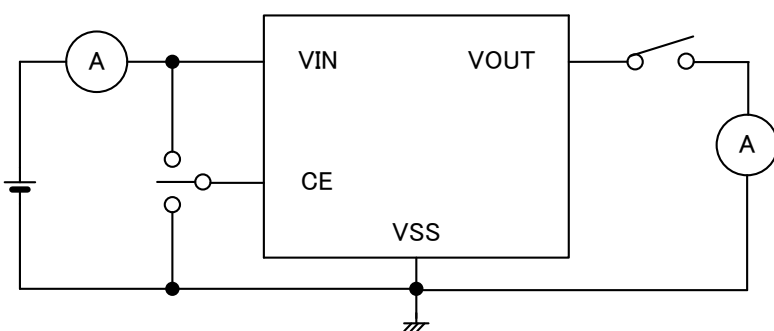
In the case of 10ms or less.

TEST CIRCUITS

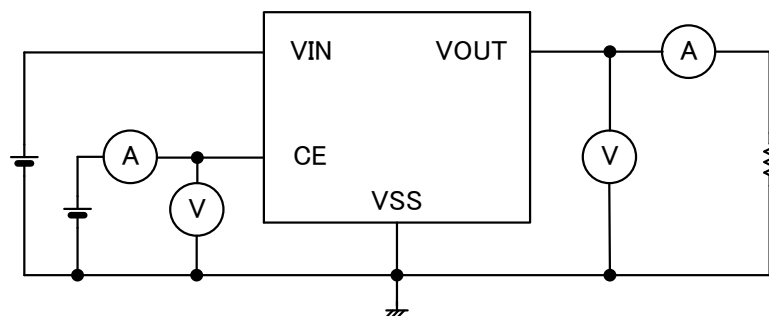
Circuit ①



Circuit ②

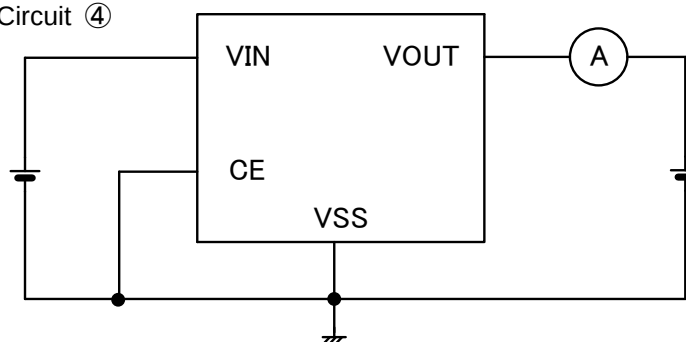


Circuit ③

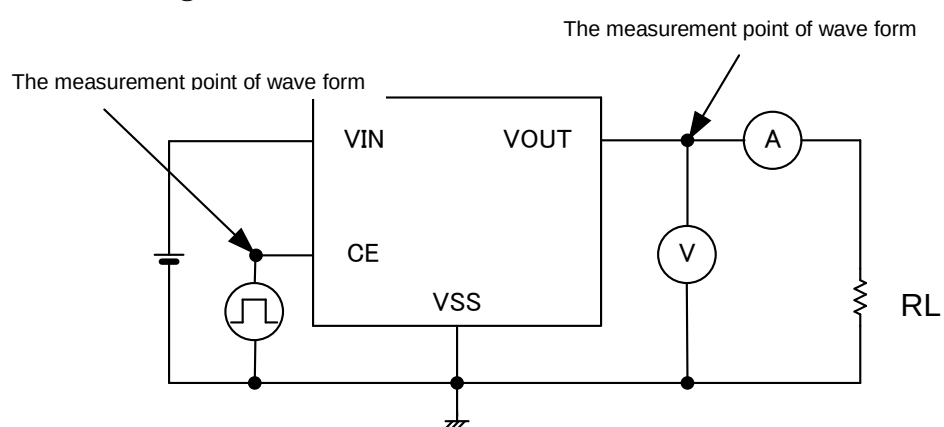


■ TEST CIRCUITS (Continued)

Circuit ④



Circuit ⑤



■ OPERATIONAL EXPLANATION

<CE Pin>

The XC8102 enables an output P-channel MOSFET switch and the IC internal circuitry to turn off by the signal to the CE pin. In the shutdown mode, the V_{OUT} pin will be pulled down to the V_{SS} by the C_L auto-discharge function (R_{DCHG}).

The output voltage becomes unstable when the CE pin is opened. If the input voltage to the CE pin is within the specified threshold voltages, the logic is fixed and the XC8102 will operate normally. However, supply current may increase as a result of the shoot-through current of internal circuitry when the medium level voltage is input to the CE pin.

<Input/Output Capacitor>

The XC8102 works well without an input and output capacitors. Also, an output capacitor of the power source can be used as an input capacitor of the XC8102 and a bypass capacitor of the driving IC can be used as an output capacitor of the XC8102.

< C_L Auto-Discharge Function>

The XC8102 series a C_L auto-discharge resistor and an N-channel transistor between the V_{OUT} pin and the V_{SS} pin. The device quickly discharges the electric charge in the output capacitor (C_L) when a low signal to the CE pin is input to turn off a whole IC circuit. The C_L auto-discharge resistance is set at 480Ω ($V_{OUT}=4.0V$ TYP. @ $V_{IN}=4.0$). Discharge time of the output capacitor (C_L) is determined by a C_L auto-discharge resistor value (R_{dischg}) and an output capacitor value. Time constant τ is defined as ($\tau = C \times R_{dischg}$). Output voltage after starting discharge can be calculated by the following formula.

$$V = V_{OUT} \times e^{-t/\tau} \quad \text{or} \quad t = \tau \ln (V_{OUT} / V)$$

V	: Output voltage after starting discharge,
V_{OUT}	: Output voltage,
t	: Discharge time,
τ	: Output discharge resistor value $R_{dischg} \times$ Output capacitor (C_L) value C

<Current Limiter, Short-Circuit Protection>

The XC8102 series contains a constant current limiter and fold-back current circuitry. The constant current limiter operates to limit output current and the fold-back current circuitry operates as short circuit protection for the output pin.

When the load current reaches the limit current, the constant current limiter operates, and the output voltage drops. The output voltage further, then the fold-back current circuitry operates to decrease the output current. When the output pin is short-circuited to the ground, the output current drops and maintains a flow about 30mA.

<Turn-on time, Turn-off time>

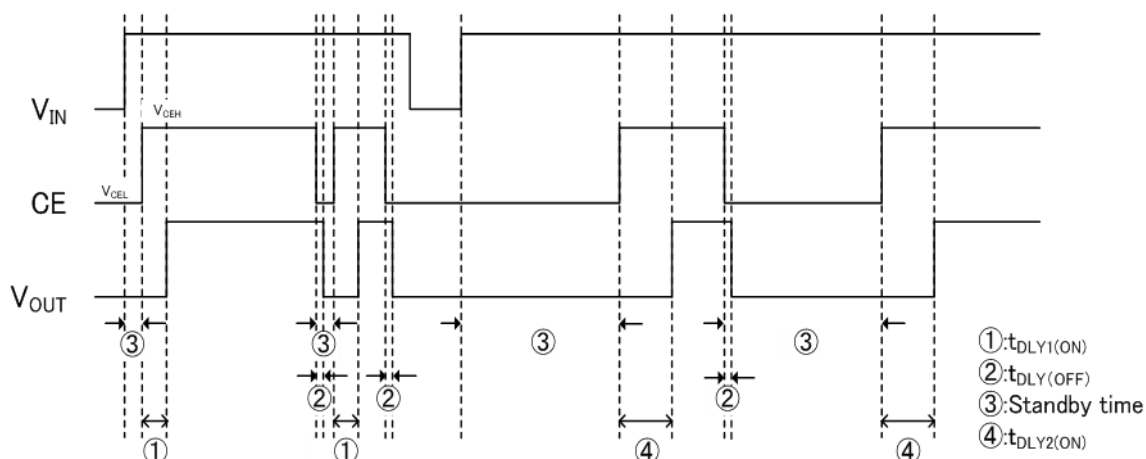
Turn-on Time is the time to reach 90% of V_{OUT} after V_{CE} entering the V_{CEH} threshold.

When the standby time after startup is short (10 ms or less) the output stands up in time of Turn on time 1.

If the standby time is long, the output stands up in time of Turn on time 2.

Turn-on Time is the time to fall to 10% of V_{OUT} after V_{CE} entering the V_{CEL} threshold.

<Turn-on time, Turn-off time TIMING CHART>

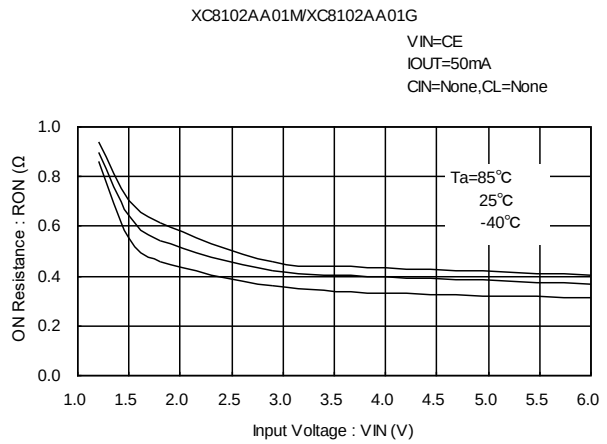
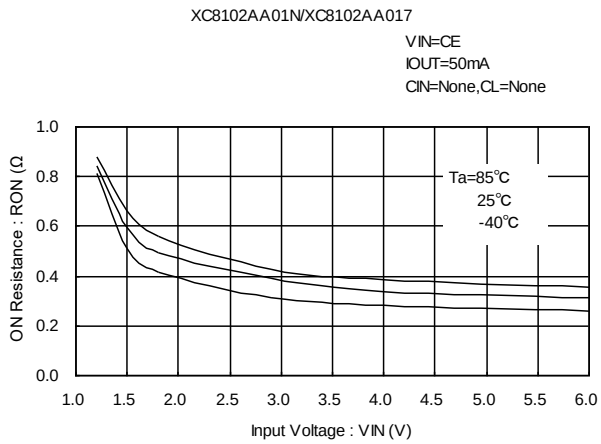


■ NOTES ON USE

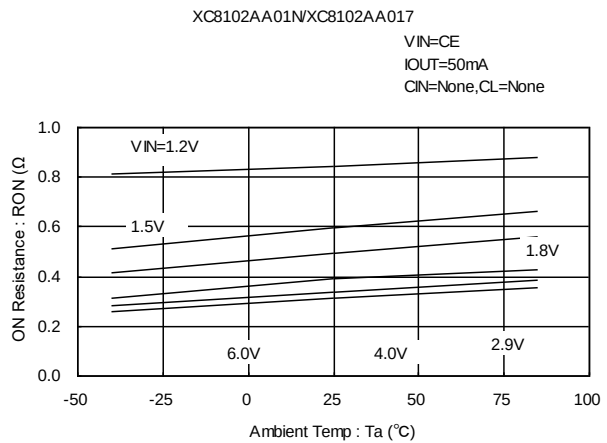
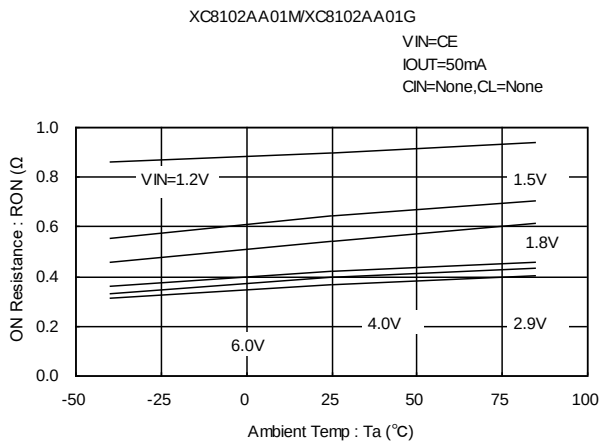
1. For temporary, transitional voltage drop or voltage rising phenomenon, the IC is liable to malfunction should the ratings be exceeded.
2. The XC8102 goes into an undefined operation when the CE pin is left open. The CE pin shall be tied to low or high level.
3. V_{OUT} pin voltage should not be applied beyond the V_{IN} pin voltage.
The IC may get damage due to the reverse current toward the V_{IN} pin.
4. The XC8102 has constant current start-up.
Please keep the start-up sequence to draw load current after raising the output voltage.
5. Current limit function is integrated. However, power dissipation may be beyond the limit before starting a fold-back current protection when used in high temperature.
6. Torex places an importance on improving our products and their reliability.
We request that users incorporate fail-safe designs and post-aging protection treatment when using Torex products in their systems.

TYPICAL PERFORMANCE CHARACTERISTICS

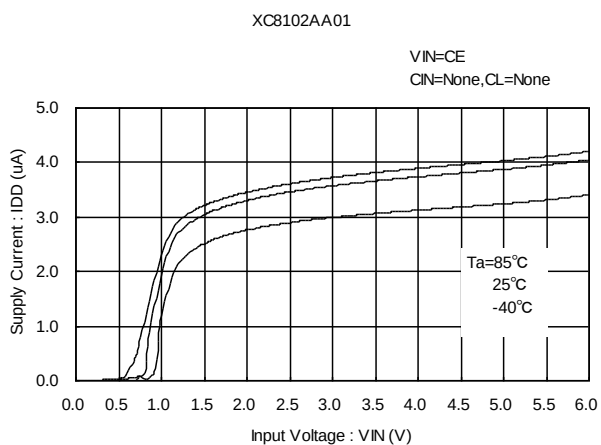
(1) ON Resistance vs. Input Voltage



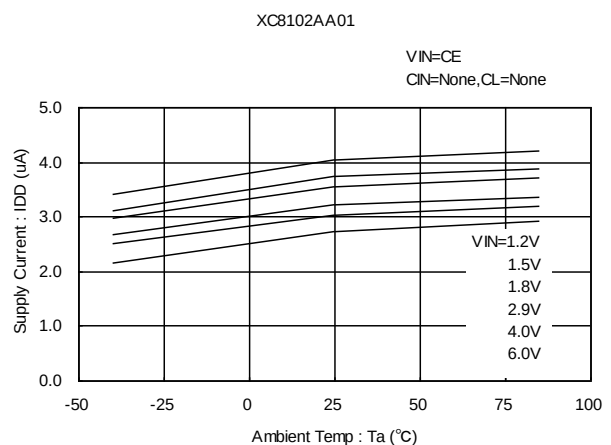
(2) ON Resistance vs. Ambient Temperature



(3) Supply Current vs. Input Voltage

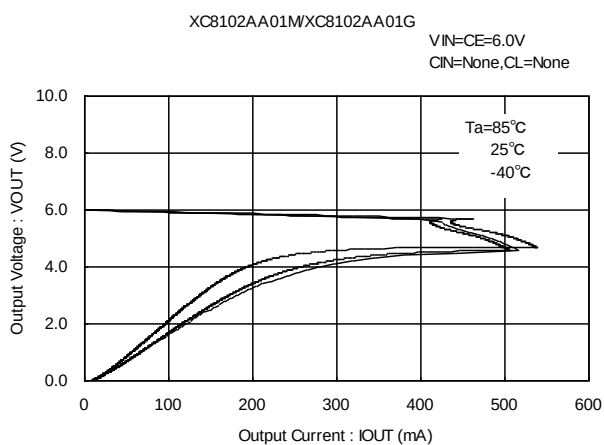
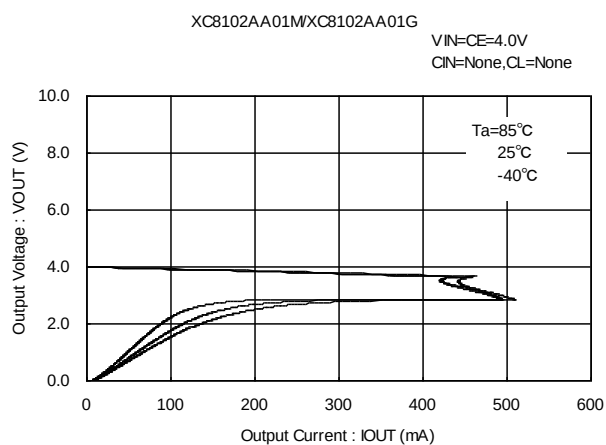
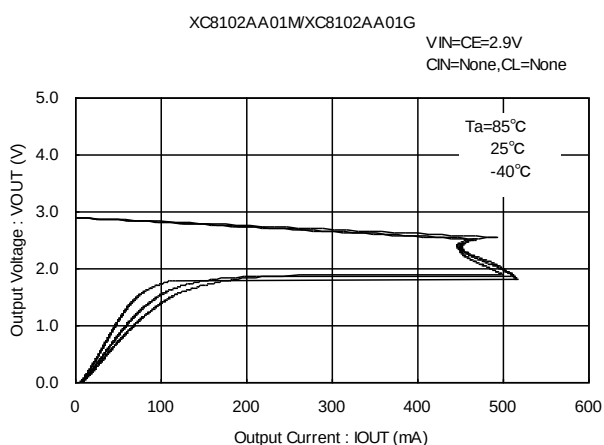
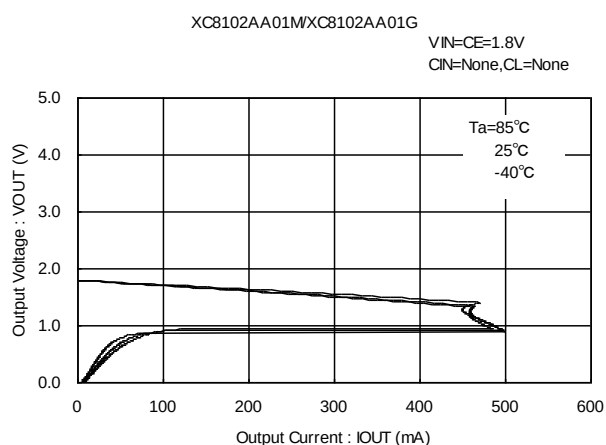
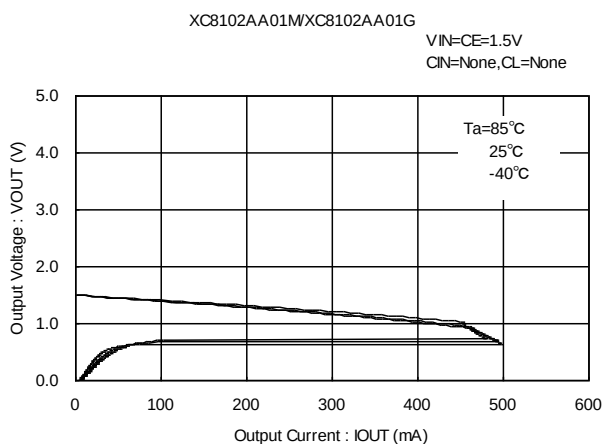
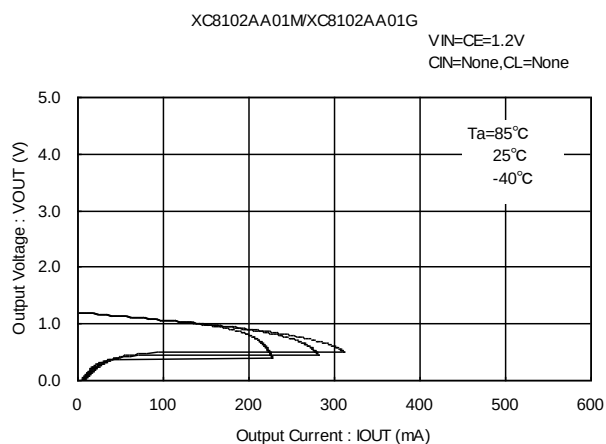


(4) Supply Current vs. Ambient Temperature



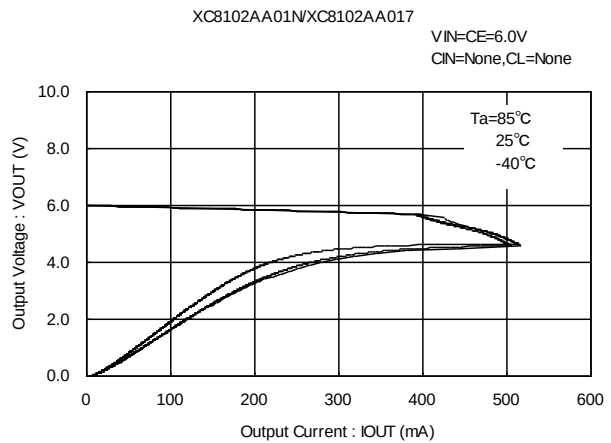
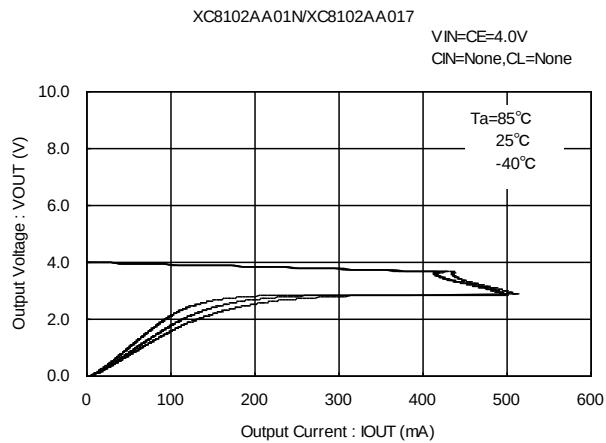
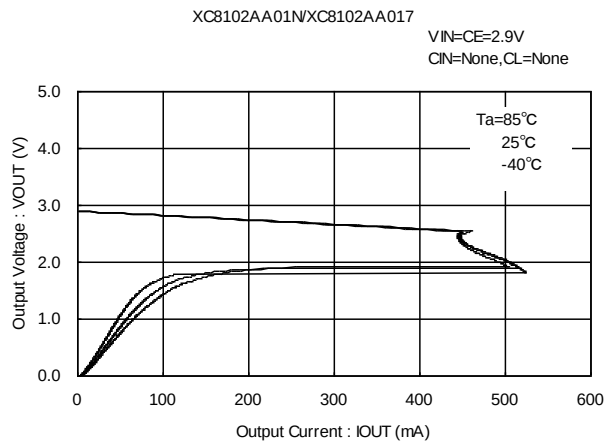
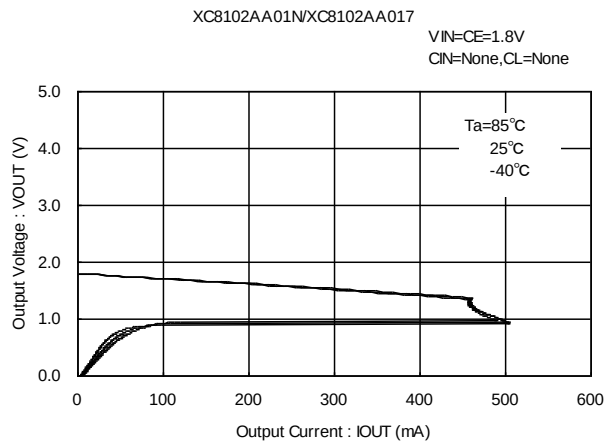
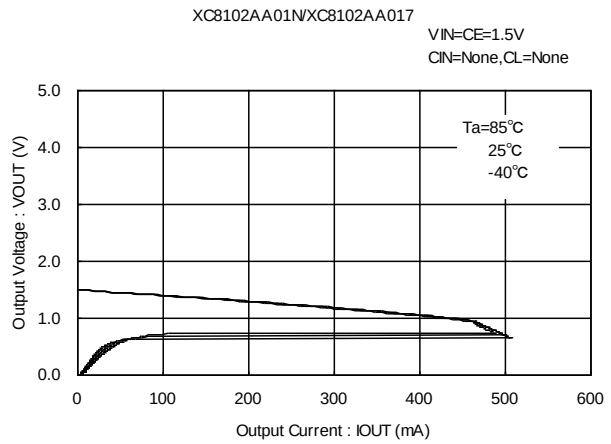
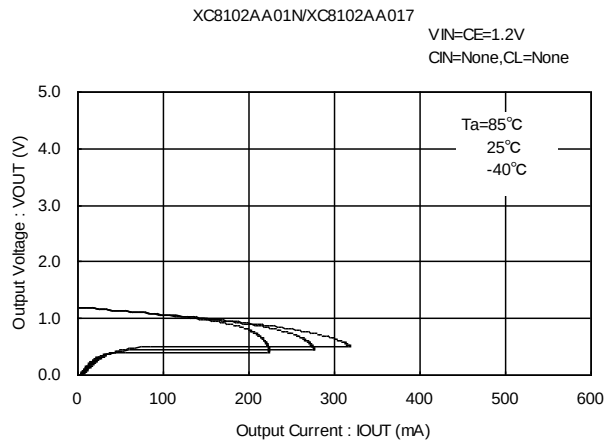
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(5) Output Voltage vs. Output Current



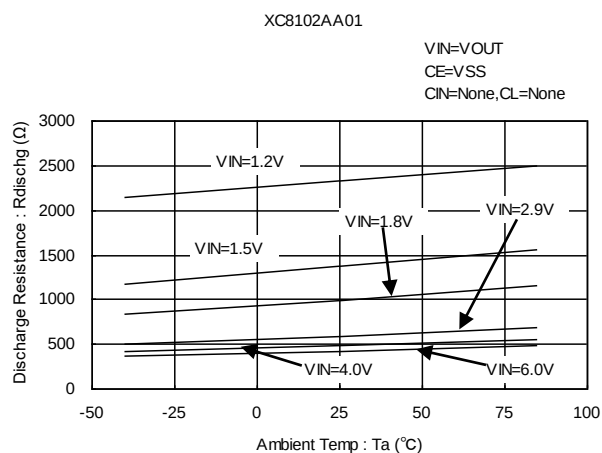
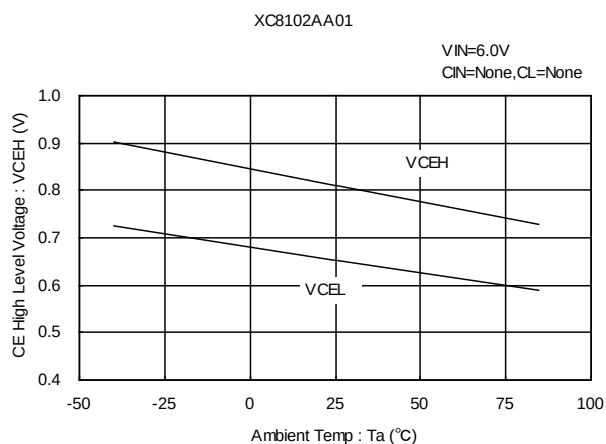
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(5) Output Voltage vs. Output Current

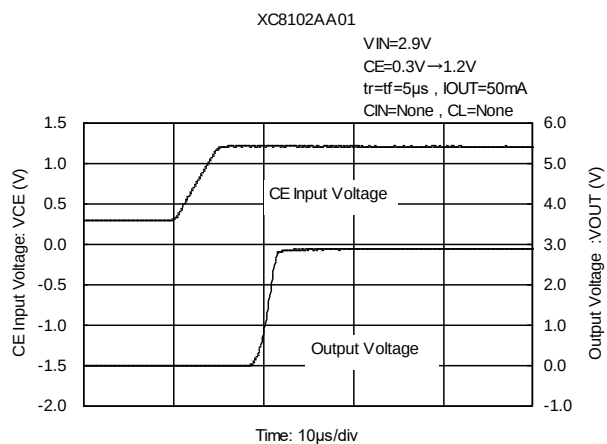
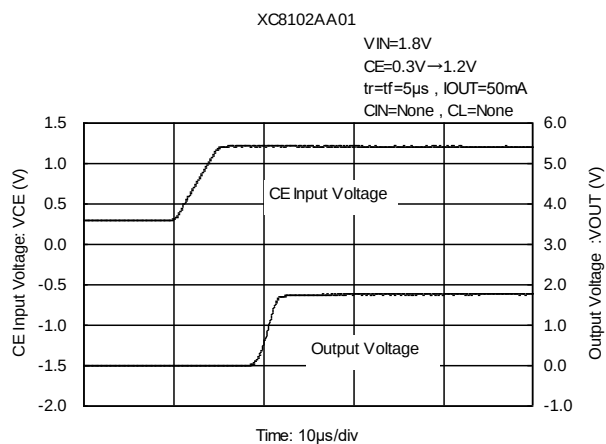
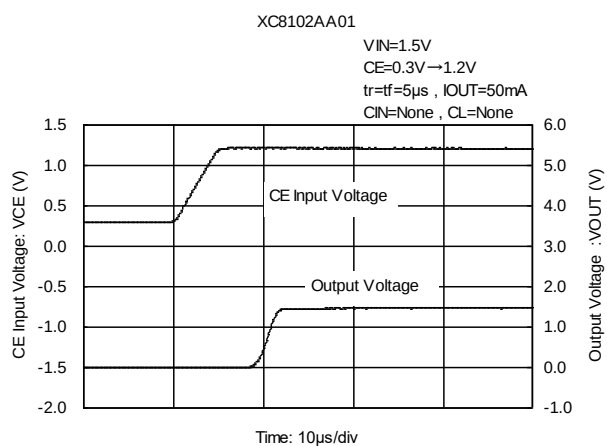
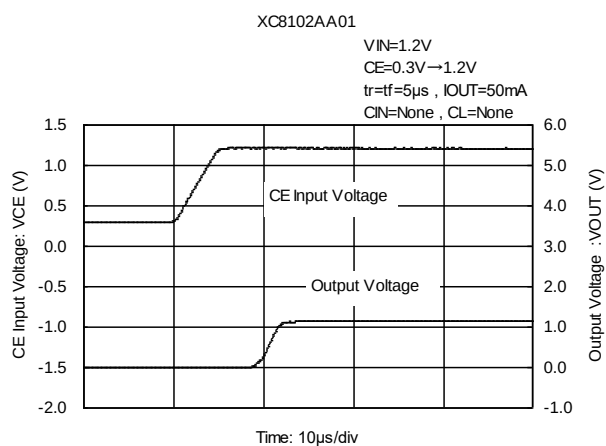


■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(6) CE Threshold Voltage vs. Ambient Temperature (7) CL Discharge Resistance vs. Ambient Temperature

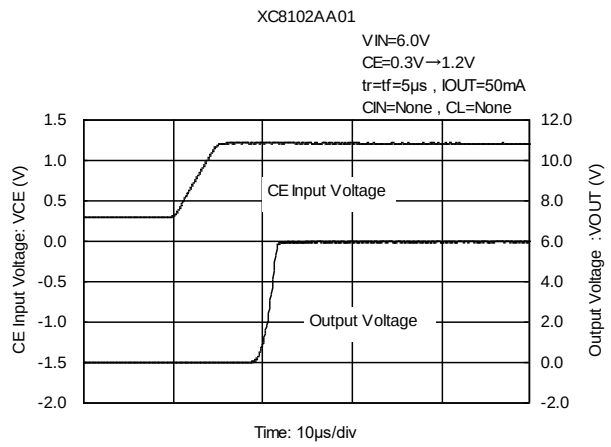
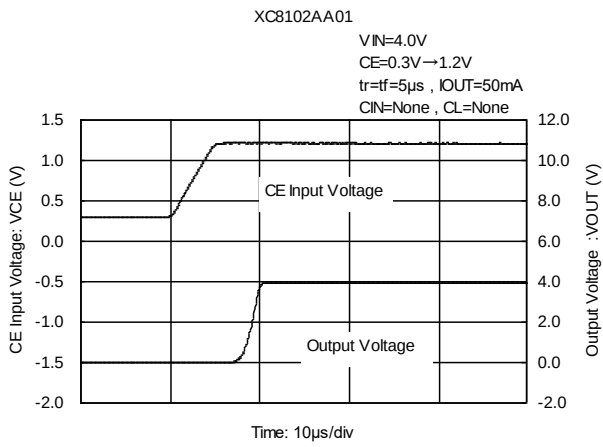


(8) Output Turn-on Time with CE

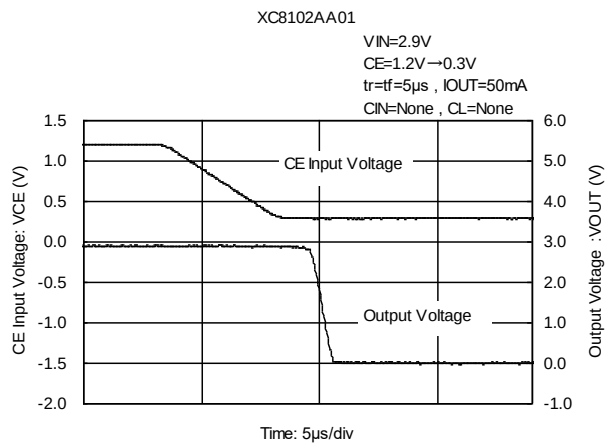
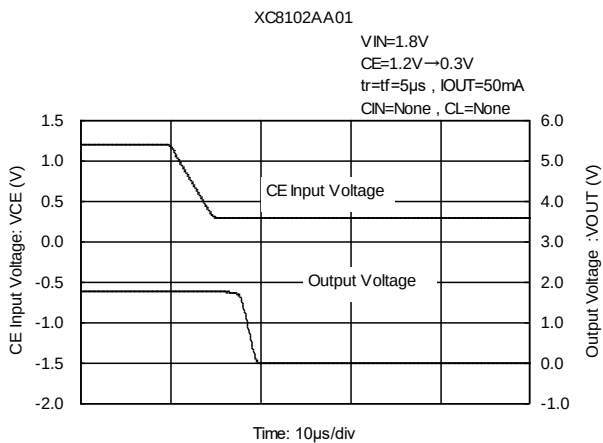
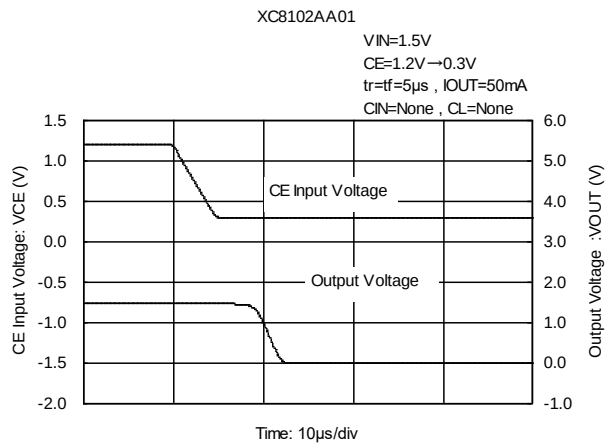
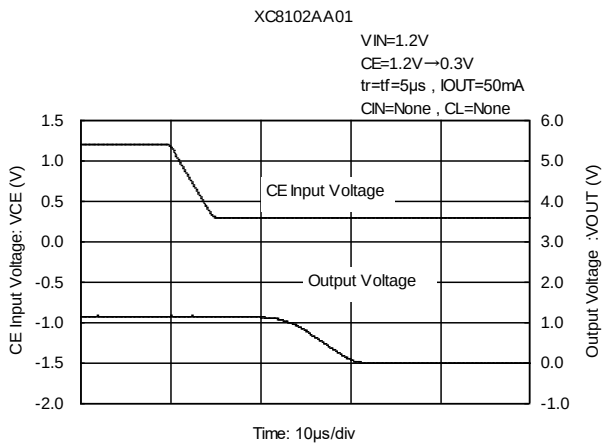


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Output Turn-on Time with CE (Continued)

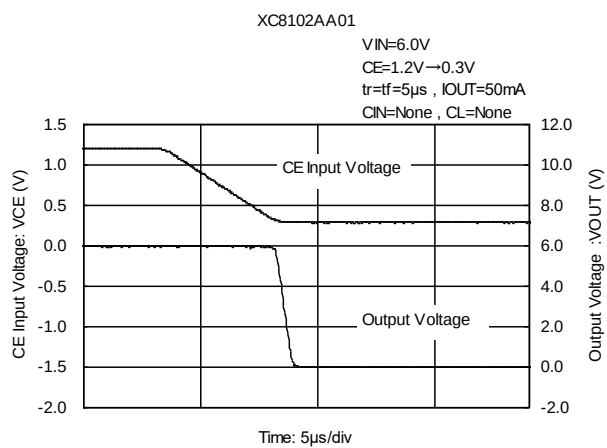
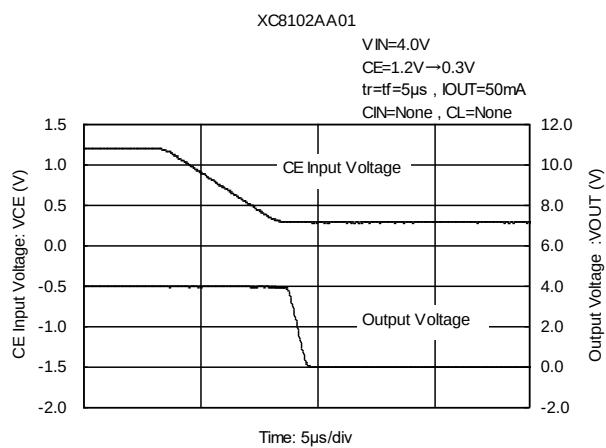


(9) Output Turn-off Time with CE



■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) Output Turn-off Time with CE (Continued)



■ PACKAGING INFORMATION

For the latest package information go to, www.torexsemi.com/technical-support/packages

PACKAGE	OUTLINE / LAND PATTERN	THERMAL CHARACTERISTICS	
SOT-25	SOT-25 PKG	Standard Board	SOT-25 Power Dissipation
		JESD51-7 Board	
SSOT-24	SSOT-24 PKG	Standard Board	SSOT-24 Power Dissipation
		JESD51-7 Board	
USP-4	USP-4 PKG	Standard Board	USP-4 Power Dissipation
USPN-4	USPN-4 PKG	Standard Board	USPN-4 Power Dissipation
USP-6B06	USP-6B06 PKG	Standard Board	USP-6B06 Power Dissipation

■ MARKING RULE

● SOT-25、USP-4、USP-6B06

① represents product series

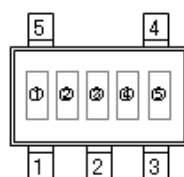
MARK	PRODUCT SERIES
C	XC8102*****

② represents CE pin logic

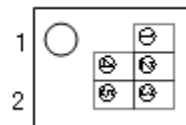
MARK	PRODUCT SERIES
F	XC8102A*****

③ represents C_L Discharge Function

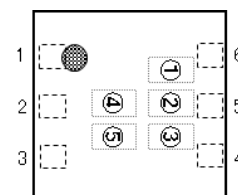
MARK	PRODUCT SERIES
C	XC8102*A****



SOT-25
(TOP VIEW)



USP-4
(TOP VIEW)



USP-6B06
(TOP VIEW)

④⑤ represents production lot number

01~09, 0A~0Z, 11~9Z, A1~A9, AA~Z9, ZA~ZZ repeated.

(G, I, J, O, Q, W excluded)

*No character inversion used.

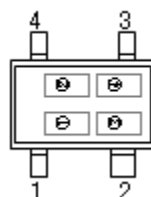
● SSOT-24、USPN-4

① represents product series

MARK	PRODUCT SERIES
C	XC8102*****

② represents CE pin logic and C_L Discharge Function

MARK	PRODUCT SERIES
5	XC8102AA****



SSOT-24
(TOP VIEW)



USPN-4
(TOP VIEW)

③④ represents production lot number

01~09, 0A~0Z, 11~9Z, A1~A9, AA~Z9, ZA~ZZ repeated.

(G, I, J, O, Q, W excluded)

*No character inversion used.

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